# Service Manual AX72 Level 1- Level 3 (basic)



Release	Date	Date Department Notes to change	
R1.0	16.11.2005	BenQ Mobile CC S CES	New document
R1.1	05.01.2006	BenQ Mobile CC S CES	Part Modification

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# 1 Key Feature

Bands	<ul> <li>Triple Band E-GSM 900 / GSM 1800 / GSM 1900</li> </ul>		
	EGSM Phase 2 / phase 2+		
	GPRS Multi Class 8		
Battery	Li-Ion Battery Pack		
	Nominal Voltage : 3.7V		
	<ul> <li>Nominal Capacity : 600 mAh</li> </ul>		
	<ul> <li>GSM Capacity: 580 mAh</li> </ul>		
	<ul> <li>Power Input: 2.0 A (0.6 ms) / 0.25 A (0.4 ms)</li> </ul>		
	Cut-off Threshold 3.2 V		
Stand-by Time	<ul> <li>up to 220 h (standard battery)</li> </ul>		
Talk Time	<ul> <li>up to 300 min (standard battery)</li> </ul>		
SIM Card	<ul> <li>Small ("Plug In") 3V SIM card (Phase II)</li> </ul>		
	<ul> <li>To insert the SIM card, the battery pack must be</li> </ul>		
0.014.4	removed.		
GSM Antenna	Integrated triple band antenna for EMEA/APAC.		
Dimensions	• 101 x 44 x 20 mm (L x W x H)		
Weight	Approx. 80 g		
Charging time	• < 2 h for 100%		
Receiver Sensitivity	• GSM 900: -102dBm (Specification, static & with fading)		
	<ul> <li>GSM 1800/1900: -102 dBm (Specification, static &amp; with fading)</li> </ul>		
	Receiver sensitivity must comply with the corresponding GSM		
	recommendations in all operating conditions (temperature,		
	battery level, etc)		
Transmitter Power	<ul> <li>GSM 900: nominal 2W (Specification: Class 4 Mobile phone)</li> </ul>		
	<ul> <li>GSM 1800/1900: nominal 1W (Specification: Class 1 Mobile phone)</li> </ul>		
	Transmitter output characteristics is according to GSM 11.10		
	specification implying all specified operating conditions		
	(temperature, battery level).		
	Transmitter set points will be specified for GSM and PCN when		
	typical values and statistical values become available.		

Speech Codec	Half Rate, Full Rate, Enhanced Full Rate and Adaptive	
	Multi Rate speech coders are available as standard.	
Temperature	<ul> <li>-10<sup>o</sup>C to +55<sup>o</sup>C (Normal operation)</li> </ul>	
Range	<ul> <li>-30<sup>o</sup>C to +85<sup>o</sup>C (Storage capability)</li> </ul>	
Display	Type: Full Graphic	
	Resolution: 130 x 130 Pixel	
	No. of colours: 65K	
	Technology: C-STN	
	Active area: 27.3mm x 27.3mm	
	<ul> <li>Pixel size: 0.21mm x 0.21mm. (1 Pixel consists of 3</li> </ul>	
	sub-pixels in red, green and blue)	
	<ul> <li>Illumination: White (3 LEDs integrated)</li> </ul>	
	Frame Rate: 15 frames/sec	
12-Block Keypad	IMF technology	
	<ul> <li>12-key-block (0-9, #, *)</li> </ul>	
	<ul> <li>two function keys (SEND, END)</li> </ul>	
	<ul> <li>ON/OFF key combined with the END key; the symbol ①</li> </ul>	
	(I inside O) is used as a symbol for ON/OFF.	
	<ul> <li>4 way-navikey</li> </ul>	
	<ul> <li>2 soft-keys for different SW-enabled functions</li> </ul>	
	<ul> <li>tactile finder on key "5"</li> </ul>	
	6 amber LEDs for keypad	
Acoustics	<ul> <li>Three-in-one-earpiece for handset, handsfree and</li> </ul>	
	ringing tones	
	Omnidirectional microphone	
	<ul> <li>Loud signal emitter (soundringer) (&gt;100dB(A) SPL</li> </ul>	
	@5cm, 'Hongkong-Spec.') only for rectangular sound	
	signals (NOT POSSIBLE for Soundringer melodies)	
	Polyphonic ringer tones 16 voices	
	Different selectable volume levels for handsfree, handset	
	and ringer mode (for the amount see Svv product	
	description)	

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# 2 AX72 Interface to Accessories

There are no specific mechanical interfaces to the car cradle. The car cradle is designed to fit the existing design. The I/O-Connector (Lumberg-slim-connector) is in use. The compatible interface is suitable to use the travel charger.

# 3 Unit Description of AX72

The AX72 is designed as a Mono Block with non-exchangeable housing. The Upper case, lower case and battery cover are painted parts. IMD Lens will be mounted by Ultrasonic, Display, 130X130; semi-bridgeless keypad, 4-way Navi-Key, 12 keys block; IMD lens; IRDA window; No ID concept will be realized on Battery cover.



# 4 Exploded View of AX72



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## 5 Disassembly of AX72

All repairs as well as disassembling and assembling have to be carried out in an ESD protected environment and with ESD protected equipment/tools. For all activities the international ESD regulations have to be considered.

For more details please check information in c – market https://market.bengmobile.com/SO/welcome.lookup.asp

There you can find the document "ESD Guideline".





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# **Benq** mobile



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#### Assembly of AX72 6

#### For the reassembly of the AX72, reverse the disassembly procedures from Step 12 to Step1. However there are some areas to be taken note of during reassembling of the phone.

During the installation of the SIM card, make sure that the SIM card is inserted properly and that the golden contact area is facing downwards. Insert the SIM card downwards to lock the SIM card into position.



Installation of the SIM card

During the installation of the battery, make sure that the hinges are properly in place (See picture below). Otherwise the battery will not be able to fit into the phone properly.



When placing the screws, set Torque to 17cNm.



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# 7 BenQ Service Equipment User Manual

#### Introduction

Every LSO repairing BenQ handset must ensure that the quality standards are observed. BenQ has developed an automatic testing system that will perform all necessary measurements. This testing system is known as:

#### **BenQ Mobile Service Equipment**

• For disassembling / assembling

Torque – Screwdriver Part Number: F30032 – P 228 – A1
Opening tool
(Case opening without
destroying)
Part Number: F30032 – P 38 – A1
Alternative Opening tool
Part Number: F30032 – P583– A1
Tweezers

#### • For testing

# All mobile phones have to be tested with the GRT – Software. The service partner is responsible to ensure that all required hardware is available.

For additional Software and Hardware options as well as the supported GRT equipment, please check the GRT User manual.

# 8 GRT Software: Functionality Configuration

Settings GRM SWUpd Equipment LSO/LSP Dota General Swup()Rics	ate ?	MobileInfo
Start GorloGo Tex	t FeperMode	Sieners Phone with S Gold

Step 1: Select "Settings >> SWUP / JPICS"

Step 2: Proceed as follows:

- Select all required Variants you need to repair (click onto the "+" in front of the product name.
- Check Com-Port setting. If necessary change it
- Check speed setting. Select always the lowest speed if your PC does not have a fast serial card
- Enter the value for "JPICS Server Timeout". Be careful, this value defines how long GRT tries to reach the server until you get an error message. Do not select a very long time



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#### Step 3: Connect to GRM Server

• Choose in the section "GRM" the "Connect to GRM Database" functionality

Settings _GRM_SWIllichte_2	
Mease       Contraction         Mobile/no       Mebile/no         Mobile/no       Mebile/no         Mobile/no       Mebile/no         Mobile/no       Mebile/no         Mobile/no       Mebile/no         Mobile/no       Mebile/no         Mebile/no       Mebile/no         Mebile/no       Mebile/no         Mebile/no       Mebile/no         Mebile/no       Mebile/no         Mebile/no       Mebile/no         Stert GoftoGo-Test       RepetMode         actual Error Description       Stert GoftoGo-Test	
Username : Mustermann	Enter your GRT-Username and Password into this fields
Password : *****	
Connect Protocol Cancel	Activate always both boxes if you connect to the database. Start with "Connect"
Status	
Configure GRM connection settings	It you IT infrastructure parameter have changed, use this button to move to the configuration mask

• End the connection with a click onto the "Exit button" (appearing after successful data exchange)

GRT Software has now finished all required settings and configuration tasks. All files have been down- and uploaded.

In dependency of the selected number of mobile phones and variants the volume of transferred date could be (~100MB)

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# 9 GRT Software: Regular Usage

Step 1: Select the section SWUpdate



Step 2: Choose the area you want to work with

SoftwareUpdate Concept					
Please choose your update concept					
PersonalRepair OperatorSwap OperatorSWUpdate					
		Cancel			

#### • Personal Repair

Personal Repair is always accessible. Basis for the decision if a SW-Update is authorised by Siemens is the so called <u>Service Release-Table</u>.

#### Example:

Mobile Phone has already SW50. <u>Service -Release-Table</u> shows SW50. In this case SW-Update is not necessary and therefore not authorized

In any case customer data can be erased on request. (xfs and mapping have to be activated) Of course **JPICS** hardware and authorisation have to be available.

#### • Operator SWAP

This area is only accessible if you are released by the service management to perform SW-Updates for Net-Operators. Basis for the decision if a SW-Update is authorised by Siemens is the so called <u>Master-Table</u>.

Customer data will be erased without any exception and any chance to influence by the user. **JPICS** hardware and authorisation have to be available.

#### • Operator SWUpdate

This area is only accessible if you are released by the service management to perform SW-Updates for Net-Operators. Basis for the decision if a SW-Update is authorised by Siemens is the so called <u>Master-Table</u>.

Like in "Personal Repair" customer data can be erased on request. (xfs and mapping have to be activated) Of course **JPICS** hardware and authorisation have to be available.

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### 9.1 Window explanation

This general explanation is valid for all SW-Update channels (Personal Repair, Operator SWAP, Operator SWUpdate)



#### **Remarks:**

In case of malfunction please check

- o Is the correct phone type selected
- Is the correct COM-Port selected
- If a variant is missing, move back to Settings select the missing variant and conncet the GRM Server. Then continue with SW-Update.

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# 9.2 Case 1: Personal Repair (green)

**Step 1:** Carry out step 1 – 4 to start SW-Update.



#### Remarks:

- The decision about a Siemens authorised SW-Update depends only on the <u>Service Release-Table</u>.
- The SW which is booted by GRT can be below the SW mentioned in the <u>Service Release Table</u>, if this SW is not released for the Net-Operator
- If **xfs** and **mapping** are activated, GRT will erase in any case the customer data even if the action is cancelled.
- If the user wants to download another variant then the automatically identified one, he has simply to select another variant from the list. Afterwards he has to start the SW-Update

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# 9.3 Case 2: Operator SWAP (red)

**Step 1:** Carry out step 1 - 4 to start SW-Update.



#### **Remarks:**

- The decision about a Siemens authorised SW-Update depends only on the <u>Master-Table</u>.
- The user has no chance to influence the decision
- Xfs and mapping are always activated there is no chance to deactivate them. GRT will erase in any case the customer data even if the action is cancelled. If the user wants to download another variant then the automatically identified one, he has simply to select another variant from the list. Afterwards he has to start the SW-Update

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## 9.4 Case 3 Operator SWUpdate (blue)

**Step 1:** Carry out step 1 – 4 to start SW-Update.



#### **Remarks:**

- The decision about a Siemens authorised SW-Update depends only on the <u>Master-Table</u>.
- The user has no chance to influence the decision
- **Xfs** and **mapping** can be activated on demand. GRT will erase in any case the customer data even if the action is cancelled.
- If the user wants to download another variant then the automatically identified one, he has simply to select another variant from the list. Afterwards he has to start the SW-Update

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#### **9 JPICS** (Java based Product Information Controlling System)



#### Overview

The following functions are available for the LSO:

- General mobile information
- Generate PINCODE
- Generate SIMLOCK UNLOCK Code
- Print IMEI labels
- Lock, Unlock and Test the BF Bus

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The access to the JPICS server which is located in Kamp–Lintfort is protected by chip card and in addition using secure socket layer (SSL) connection.

The JPICS server is only available for authorized users with a specially coded smart card. These smart cards and the administration of the JPICS web server and the PICS database – server can only be provided by the JPICS – TRUST – Center of the <u>responsible</u> <u>department</u> in Kamp–Lintfort.

In case of any questions or requests concerning smart cards or administration of the databases please ask your responsible BenQ Customer Care Manager.

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#### Installation overview

The following installation description assumes that a web browser is already installed. JPICS is tested with the following browsers:

- 1. Internet Explorer Version 5.5 and higher
- 2. <u>Netscape</u> Version 6 and higher

For further information regarding supported browsers, browser version and supported operating systems, see the <u>Sun FAQ's</u>.

Here is a step by step instruction to install all the required components:

#### It is necessary to follow this order!

- 1. Smart Card Reader (Omnikey: Cardman 2020 USB or Cardman 3121 USB)
- 2. <u>CardOS interface</u> (Siemens Version 3.0 B)
- 3. Java Runtime Environment (Sun)
- 4. Java additional components

# Every user is responsible for a proper installation matching the license agreements.

For installation and further access you need the following:

- 1. The JPICS Installation CD
- The Smart Card JPICS. These cards can be ordered via your responsible Customer Care Manager within Siemens or on <u>http://jpics.siemens.com/jpics/admin/request-new\_jpics.jsp</u>
- 3. A supported Smart Card Reader (Omnikey Cardman) in order to access your Smart Card.

<u>Remark:</u> We recommend using Cardman 2020 USB or Cardman 3121 USB. Serial card readers are not supported!!!

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#### **Generate Codes**

In the JPICS application you can choose to generate:

- Masterphone codes
- Simlock Unlock Codes

#### **Masterphone codes**

The Masterphone code is used to unlock blocked mobiles.

**Masterphone codes** can only be supplied for mobiles which have been delivered in a regular manner.

🗿 JPICS PICS interne	et portal Microsoft Internet Explorer bereitgestellt von BenQ mobile Kamp-Lintfort	
	Beng mobile Global Home	My-BenQ E-Mail
<b>Benq</b> mobile	KLFS1D0C     Mask     Masterphone-Code*       Version: 1.0     Username     SparkaJP	16.11.2005 15:22
Mobile info	Troubleshooting Masterphone-Code	
IMEI label printing	IMEI         351630000011691         Execute         DB-Location         Kamp-Lintfort           Mobile data	
Masterphone codes Simlock unlock co	Producttype SL55 Deliverypartnumber L36880-N4910-A150-31	
BFBus - Status	Warranty Status Normal	51.55
	Delivery information Delivery note LC00001579 Delivery date 15.09.05 Mobile codes Mobile unlock code *#0003*40158737#	
		]
		connected

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#### Simlock – Unlock – Code

The **Simlock – Unlock – Codes** can only be generated if the following conditions are given:

- Mobile must have an active **Simlock** inside.
- The user must be given the authorization to obtain **Simlock Unlock Codes** for the variant of the operator to which the mobile was delivered last time.

🗿 JPICS PICS interne	et portal Microsoft Internet E	xplorer bereitgestellt	von BenQ mobile Kamp-Lintfort	
		xtra Window Heln	Global Home	My-BenQ E-Mail
- PONE				
Beng mobile	KLFS1D0C Version: 1.0	Mask 9 Username 9	5imlock-Unlock-Code 5parkaJP	16.11.2005 15:23
	Simlock-Unlock-Code			
Mobile info	Get information for given IMEI			
IMEI label printing	IMEI 350673547180612 Exe	cute DB-Location	Kamp-Lintfort	
Masterphone codes	Mobile data	Deliverypartnumber	136880.55100-7130-15	1
Simlock unlock co	SW version 049	 Partoumber	S30880-S5100-A139-14	88
	Warraphy 21.08.05	Status	Normal	
BFBus - Status	D.L.			C45
	Delivery information	Daliusen	4444 22 00 02	
		Delivery	yoace j22.08.03	
	Mobile codes	•		
	Networkcode	Network Mastercode		
	S. Providercode	S. Provider Mastercode		
	SIM-Mastercode	SIM-Reeanablecode		
	Corporatecode	Corporate Mastercode		
	Network Subnet Code	Network Subnet Maste	rcode  *#0004*28101158#	
	,			

## **Printing IMEI label**

The module "**printing IMEI label**" offers the possibility to re-print IMEI labels for mobiles again.

🗿 JPICS PICS interne	et portal Microsoft Internet Explorer bereitgestellt von BenQ mobile Kamp-Lintfort	
	BENQ mobile Global Home My Action JPICS user menu View Extra Window Help	r-BenQ E-Mail
Beno mobile	KLFS1D0C Mask Reprint IMEI Label Version: 1.4 Username SparkaJP	16.11.2005 15:24
Mobile info IMEI label printing Masterphone codes Simlock unlock co BFBus - Status	Reprint IMEI Label	

You are able to print 1 label in just one step.

To prevent that misaligned labels are being printed, the setting "Print test labels =  $\checkmark$ " is activated by default. After having printed a well aligned test label you can uncheck the setting and print the correct label.

#### Hint:

For correct printing of IMEI labels you must have a **Zebra – label printer** with special material that fits for label printing. This printer has to be connected to local LPT1 printer port (also see Installation of IMPRINT) and MUST feature a printing resolution of 300dpi.

# 9 International Mobile Equipment Identity, IMEI

The mobile equipment is uniquely identified by the International Mobile Equipment Identity, IMEI, which consists of 15 digits. Type approval granted to a type of mobile is allocated 6 digits. The final assembly code is used to identify the final assembly plant and is assigned with 2 digits. 6 digits have been allocated for the equipment serial number for manufacturer and the last digit is spare.

The part number for the AX72 is S30880-S2860-#xxx where the last for letters specify the housing and software variant.

AX72 series IMEI label is accessible by removing the battery.

Re – use of IMEI label is possible by using a hair – dryer to remove the IMEI label.

On this IMEI label, BenQ has also includes the data code for production or service, which conforms to the industrial standard DIN EN 60062. The data code comprises of 2 characters: first character denotes the **year** and the second character denotes the **month**.

CODE	Year	Month	CODE
Р	2002	MARCH	3
R	2003	APRIL	4
S	2004	ΜΑΥ	5
Т	2005	JUNE	6
U	2006	JULY	7

For example: S5

To display the IMEI number, exit code and SW/HW version, key: \* # 0 6 #

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# **10 General Testing Information**

#### **General Information**

The technical instruction for testing GSM mobile phones is to ensure the best repair quality.

#### Validity

This procedure is to apply for all from BenQ Mobile authorized up to level 3 workshops.

#### Procedure

All following checks and measurements have to be carried out in an ESD protected environment and with ESD protected equipment/tools. For all activities the international ESD regulations have to be considered.

Get delivery:

- Ensure that every required information like fault description, customer data a.s.o. is available.
- > Ensure that the packing of the defective items is according to packing requirements.
- Ensure that there is a description available, how to unpack the defective items and what to do with them.

Enter data into your database:

(Depends on your application system)

- Ensure that every data, which is required for the IRIS-Reporting is available in your database.
- > Ensure that there is a description available for the employees how to enter the data.

Incoming check and check after assembling:

#### **!! Verify the customers fault description!!**

- After a successful verification pass the defective item to the responsible troubleshooting group.
- If the fault description can not be verified, perform additional tests to save time and to improve repair quality.
  - Switch on the device and enter PIN code if necessary unblock phone.
  - Check the <u>function</u> of all **keys** including **side keys**.
  - Check the display for error in line and row, and for illumination.
  - Check the **ringer/loudspeaker** acoustics by individual validation.
  - Perform a **GSM Test** as described on page 36.

Check the storage capability:

- > Check internal resistance and capacity of the battery.
- > Check battery charging capability of the mobile phone.
- > Check charging capability of the power supply.
- > Check current consumption of the mobile phone in different mode.

Visual inspection:

- > Check the entire board for liquid damages.
- > Check the entire board for electrical damages.
- > Check the housing of the mobile phone for damages.

SW update:

Carry out a software update and data reset according to the master tables and operator/customer requirements.

#### **Repairs:**

The disassembling as well as the assembling of a mobile phone has to be carried out by considering the rules mentioned in the dedicated manuals. If special equipment is required the service partner has to use it and to ensure the correct function of the tools.

If components and especially soldered components have to be replaced all rules mentioned in dedicated manuals or additional information e.g. service information have to be considered

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# With the availability of the GRT Test /Alignment software, this tool has to be used to perform the outgoing test!

>Connect the mobile/board via internal antenna (antenna coupler) and external antenna (car cradle/universal antenna clip) to a GSM tester

>Use a Test SIM

For Triple Band phones use a separate test case, if the test software allows only one handover. Skip the GSM Band test cases if not performed by the mobile phone

example:	1. Test file	Band 1 = GSM900 / Band 2 = GSM180
	2. Test file	Band 1 = GSM1900

#### Internal Antenna

Test	case	Parameter	Measurements	Limits
1	Location Update	• GSM Band 1 • BS Power = -55 dBm • middle BCCH	Display check	<ul> <li>individual check</li> </ul>
2	Call from BS	<ul> <li>low TCH</li> <li>highest PCL</li> <li>BS Power = -75 dBm</li> <li>middle BCCH</li> </ul>	<ul> <li>Ringer/Loudspeaker check</li> </ul>	• individual check
3	TX GSM Band 1	<ul> <li>low TCH</li> <li>highest PCL</li> <li>BS Power = -75 dBm</li> <li>middle BCCH</li> </ul>	<ul> <li>Frequency Error</li> <li>Phase Error RMS</li> <li>Phase Error Peak</li> <li>Average Power</li> <li>Power Time Template</li> </ul>	GSM Spec.
4	Handover to GSM Band 2 Including Handover Check			
5	TX GSM Band 2	<ul> <li>low TCH</li> <li>highest PCL0</li> <li>BS Power = -75 dBm</li> <li>middle BCCH</li> </ul>	<ul> <li>Frequency Error</li> <li>Phase Error RMS</li> <li>Phase Error Peak</li> <li>Average Power</li> <li>Power Time Template</li> </ul>	GSM Spec.
6	Call relaese from BS			

Ext	ernal Antenna			
7	Call from MS	• GSM900 • high TCH • second highest PCL • BS Power = -75 dBm • middle BCCH	Keyboard check	• individual check
8	TX GSM Band 1	<ul> <li>high TCH</li> <li>second highest PCL</li> <li>BS Power = -75 dBm</li> <li>middle BCCH</li> </ul>	<ul> <li>Frequency Error</li> <li>Phase Error RMS</li> <li>Phase Error Peak</li> <li>Average Power</li> <li>Power Time Template</li> </ul>	GSM Spec.
9	RX GSM Band 1	<ul> <li>high TCH</li> <li>BS Power = -102 dBm</li> <li>50 Frames</li> <li>middle BCCH</li> </ul>	RX Level     RX Qual     BER Class Ib     BER Class II     BER Erased Frames	GSM Spec.
10	Handover to GSM Band 2 Including Handover Check			
11	TX GSM Band 2	<ul> <li>high TCH</li> <li>second highest PCL</li> <li>BS Power = -75 dBm</li> <li>middle BCCH</li> </ul>	<ul> <li>Frequency Error</li> <li>Phase Error RMS</li> <li>Phase Error Peak</li> <li>Average Power</li> <li>Power Time Template</li> </ul>	GSM Spec.
12	RX GSM Band2	<ul> <li>high TCH</li> <li>BS Power = -102 dBm</li> <li>50 Frames</li> <li>middle BCCH</li> </ul>	RX Level     RX Qual     BER Class lb     BER Class II     BER Erased Frames	GSM Spec.
13	Call relaese from MS			

#### **Final Inspection:**

The final inspection contains:

- 1) A 100% network test (location update, and set up call).
- 2) Refer to point 3.3.
- 3) A random sample checks of:
  - Data reset (if required)
  - Optical appearance
  - complete function

4) Check if PIN-Code is activated (delete the PIN-Code if necessary).

Basis is the international standard of **DIN ISO 2859**.

Use Normal Sample Plan Level II and the Quality Border 0,4 for LSO.

**Remark**: All sample checks must be documented.

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# Annex 1

Test SIM Card

There are two different "Test SIM Cards" in use:

1) Test SIM Card from the company "ORGA"

Pin 1 number:	0000
PUK 1 :	12345678
Pin 2 number:	0000
PUK 2 :	23456789

2) Test SIM Card from the company "T-D1"

Pin 1 number:	1234
PUK :	76543210
Pin 2 number:	5678
PUK 2 :	98765432

# **Benq** mobile

# Annex 2

#### **Battery Date Code overview**

Varta Date code example → Year (N:2001, O:2002) Month (1:Jan, 2:Feb,9:Sep, O:Oct, N:Nov, D:Dec) Revision Letter (A, B,)		Supplier Code (Maker's marking)
Hitachi / Maxwell Date code example Year (N:2001, O:2002) Month (1:Jan, 2:Feb,9:Sep, O:Oct, N:Nov, D:Dec) Revision Letter (A, B,)	<u>N 9 A MX</u>	Supplier Code (Maker's marking)
Sanyo Date code example Year (N:2001, O:2002) Month (1:Jan, 2:Feb,9:Sep, O:Oct, N:Nov, D:Dec) Revision Letter (A, B,)	<u>N 9 A SY</u>	Supplier Code (Maker's marking)
NEC Date code example Year (N:2001, O:2002) Month (1:Jan, 2:Feb,9:Sep, O:Oct, N:Nov, D:Dec) Revision Letter (A, B,)	<u>N 8 A NT</u>	Supplier Code (Maker's marking)
Panasonic Date code example → Year (N:2001, O:2002) Month (1:Jan, 2:Feb,9:Sep, O:Oct, N:Nov, D:Dec) Revision Letter (A, B,)	<u>o n a pan</u>	Supplier Code (Maker's marking)
Sony Date code example → Year (O:2002, P:2003) Month (1:Jan, 2:Feb,9:Sep, O:Oct, N:Nov, D:Dec) Revision Letter (A, B,)		Supplier Code (Maker's marking)

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# **11 Introduction of Service Repair Documentation Level 3 – AX72**

#### 11.1 Purpose

This Service Repair Documentation is intended to support Service partners to carry out repairs on BenQ repair level 3. The described failures shall only be repaired in BenQ authorized local workshops.

The level 3 (former Level 2.5light) partners are obliged to repair level 3 classified boards, up to their repair level, under consideration of this repair instruction.

All repairs have to be carried out in an ESD protected environment and with ESD protected equipment/tools. For all activities the international ESD regulations have to be considered.

Check at least weekly C-market for updates and consider all AX72 related Customer Care Information

Scrap Handling: All Scrap information given in this manual are related to the SCRAP-Rules and instructions.

Attention: Consider the new "LEAD-FREE" soldering rules (available in the communication market), avoid excessive heat.

#### 11.2 Scope

This document is the reference document for all BenQ mobile authorised Service Partners which are released to repair BenQ mobile phones up to level 2.5 light.

#### **11.3 Terms and Abbreviations**

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# 12 List of available level 3 (basic)spare parts

(according to Component Matrix V1.09 - check C-market for updates)

Product	ID	Order Number	Description CM
AX72	C1605	L36853-C6224-M6	CAPACITOR 2220N (Cap-Type3)
AX72	R1614	L50652-C472-J2	RESISTOR 4K7 (Res-Type11)
AX72	V286	L36840-L2056-D670	LED AMBER
AX72	V287	L36840-L2056-D670	LED AMBER
AX72	V288	L36840-L2056-D670	LED AMBER
AX72	V289	L36840-L2056-D670	LED AMBER
AX72	V290	L36840-L2056-D670	LED AMBER
AX72	V291	L36840-L2056-D670	LED AMBER
AX72	X1400	L36334-Z97-C213	CONNECTOR BATTERY 3-POL
AX72	X1603	L36334-Z97-C337	CONNECTOR SIM CARD READER K1
AX72	X211	L36334-Z93-C303	IO-JACK SLIM 12-POL
AX72	X2202	L36334-Z97-C205	CONNECTOR DISPLAY 10POL

# **13 Hardware requirements**

(according to General soldering information V1.3 - check C-market for updates)

Jigs, Tools and working materials for all described repairs:

- hot air blower
- soldering gun
- tweezers
- flux
- solder

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# 14 AX72 Board layout

#### Upper board side



#### Lower board side



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# **15 SIM Card Problems**



#### Connector SIM Card Reader

Use soldering iron to remove defective component. Avoid excessive heat! Watch surrounding components! Resolder new component afterwards.

E-commerce order number: E-commerce order name: Soldering temperature: IRIS Diagnose Code: L36334-Z97-C337 CONNECTOR SIM CARD READER K1 ~ 360°C Tip Temp. 43300 Interface/SIM Cardreader/Mechanical Damage

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# **16 IO Connector Problems**



Connector IO Jack

Use soldering iron to remove defective component. Avoid excessive heat! Watch surrounding components! Resolder new component afterwards.

E-commerce order number:	L36334-Z93-C303
E-commerce order name:	IO-JACK SLIM 12-POL
Soldering temperature:	~ 360°C Tip Temp.
IRIS Diagnose Code:	46100 Interface/Charging Connector/Mechanical Damage
-	47300 Interface/Data Interface/Mechanical Damage
	4B100 Interface/Headset Connector/Mechanical Damage

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# **17 LED\_Keypad illumination Problems**





#### LED\_ KEYPAD

Remove metal dome sheet before replace LED's Use soldering iron to remove defective component. Avoid excessive heat! Watch surrounding components! Resolder new component afterwards. The metal dome jip must be used to place the metal dome sheet.

E-commerce order number:	L36840-L2056-D670
E-commerce order name:	LED AMBER
Soldering temperature:	~ 360°C Tip Temp.
IRIS Diagnose Code:	22000 Display / Background Illumination

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# **18 Battery Connector Problems**



#### **Connector BATTERY**

Use hot air blower to remove defective component. Avoid excessive heat! Watch surrounding components! Resolder new component afterwards.

3-POL
l Damage

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# **19 Display Problems**

Fault Symptoms	
Customer:	GRT:
Display problems, like missing lines or columns on the LCD	Display problems
or display contrast problems or illumination problems	



#### Connector DISPLAY

Use hot air blower to remove defective component. Avoid excessive heat! Watch surrounding components! Resolder new component afterwards.

E-commerce order number:	L36334-Z97-C205
E-commerce order name:	CONNECTOR DISPLAY 10POL
Soldering temperature:	~ 360°C Tip Temp.
IRIS Diagnose Code:	21000 Display / Performance
-	22000 Display / Background Illumination

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